

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Serial No.: 10/621,863  
Applicant: Tingkai Li *et al.*  
Filed: July 16, 2003  
Group #: 2823  
Examiner: Hsien Ming Lee

Confirmation Number: 1755

**RECEIVED  
CENTRAL FAX CENTER****SEP 02 2004**

Docket No: SLA.0709  
Customer No: 27518  
For: MOCVD OF TiO<sub>2</sub> THIN FILM FOR USE AS FeRAM H<sub>2</sub> PASSIVATION LAYER

MS AMENDMENT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

**RESPONSE TO OFFICE ACTION UNDER 37 C.F.R. § 1.111  
Introductory Comments**

In response to the Office Action dated June 30, 2004, please amend the above-identified Application as follows:

**Amendment to the Specification** begins on page 2 of this paper.

**Amendment to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Amendment to the Drawings** None

**Remarks/Arguments** begin on page 9 of this paper.

**An Appendix** is not included.

Page 1 Response to Office Action under 37 C.F.R. § 1.111 for Serial No. 10/621,863